



# PMEG2005AEL

0.5 A ultra low  $V_F$  MEGA Schottky barrier rectifier in leadless ultra small SOD882 package

Rev. 03 — 15 January 2010

Product data sheet

## 1. Product profile

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### 1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier diode with an integrated guard ring for stress protection encapsulated in a SOD882 leadless ultra small plastic package.

### 1.2 Features

- Forward current: 0.5 A
- Reverse voltage: 20 V
- Ultra low forward voltage
- Leadless ultra small plastic package
- Power dissipation comparable to SOT23

### 1.3 Applications

- Ultra high-speed switching
- Voltage clamping
- Protection circuits
- Low voltage rectification
- High efficiency DC-to-DC conversion
- Low power consumption applications

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Value	Unit
$I_F$	forward current	0.5	A
$V_R$	reverse voltage	20	V

## 2. Pinning information

Table 2. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode	<p>Bottom view</p> <p>Top view</p> <p>001aaa332</p>	<p>sym001</p>
2	anode		

[1] The marking bar indicates the cathode.

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG2005AEL	-	leadless ultra small plastic package; 2 terminals; body 1.0 × 0.6 × 0.5 mm	SOD882

## 4. Marking

Table 4. Marking

Type number	Marking code
PMEG2005AEL	F2

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	continuous reverse voltage		-	20	V
$I_F$	continuous forward current		-	0.5	A
$I_{FRM}$	repetitive peak forward current	$t_p \leq 1$ ms; $\delta \leq 0.25$	-	2.5	A
$I_{FSM}$	non-repetitive peak forward current	$t = 8$ ms square wave	-	3	A
$T_j$	junction temperature		[1] -	150	°C
$T_{amb}$	operating ambient temperature		[1] -65	+150	°C
$T_{stg}$	storage temperature		-65	+150	°C

- [1] For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determining the reverse power losses  $P_R$  and  $I_{F(AV)}$  rating will be available on request.

## 6. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<a href="#">[1]</a> <a href="#">[2]</a> 500	K/W

- [1] Refer to SOD882 standard mounting conditions (footprint), FR4 with 60  $\mu\text{m}$  copper strip line.
- [2] For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determining the reverse power losses  $P_R$  and  $I_{F(AV)}$  rating will be available on request.

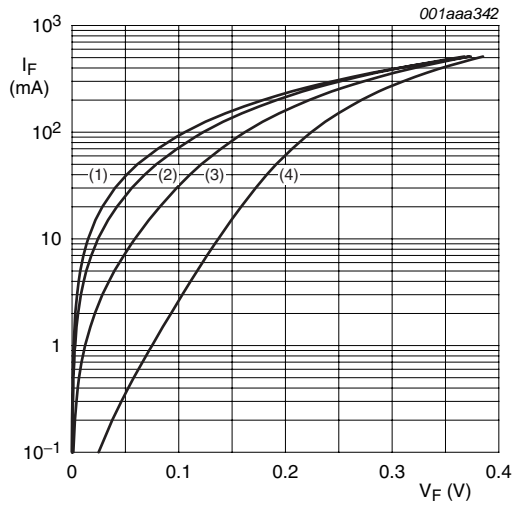
## 7. Characteristics

**Table 7. Characteristics**

$T_{amb} = 25\text{ }^\circ\text{C}$  unless otherwise specified.

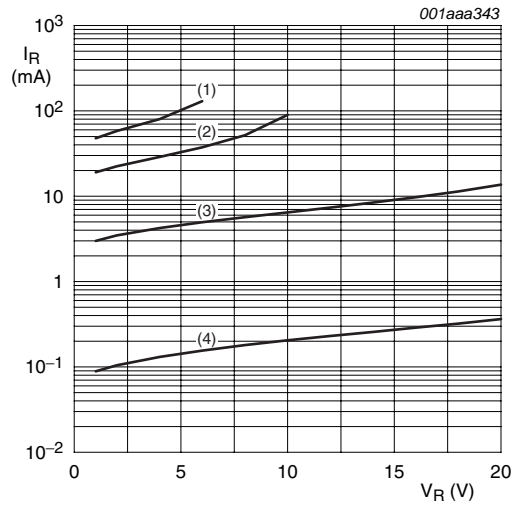
Symbol	Parameter	Conditions	Typ	Max	Unit
$V_F$	continuous forward voltage	see <a href="#">Figure 1</a> ;			
		$I_F = 0.1\text{ mA}$	25	60	mV
		$I_F = 1\text{ mA}$	75	110	mV
		$I_F = 10\text{ mA}$	135	190	mV
		$I_F = 100\text{ mA}$	220	290	mV
		$I_F = 500\text{ mA}$	375	440	mV
$I_R$	continuous reverse current	see <a href="#">Figure 2</a> ; <a href="#">[1]</a>			
		$V_R = 10\text{ V}$	210	600	$\mu\text{A}$
		$V_R = 20\text{ V}$	370	1500	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 1\text{ V}$ ; $f = 1\text{ MHz}$ ; see <a href="#">Figure 3</a>	19	25	pF

- [1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$ .



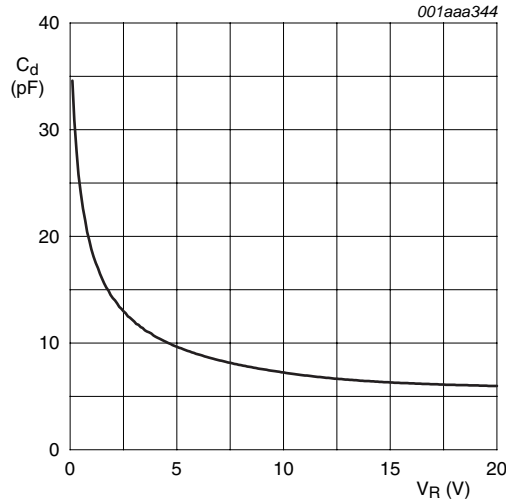
- (1)  $T_j = 150\text{ }^\circ\text{C}$
- (2)  $T_j = 125\text{ }^\circ\text{C}$
- (3)  $T_j = 85\text{ }^\circ\text{C}$
- (4)  $T_j = 25\text{ }^\circ\text{C}$

**Fig 1. Forward current as a function of forward voltage; typical values**



- (1)  $T_j = 150\text{ }^\circ\text{C}$
- (2)  $T_j = 125\text{ }^\circ\text{C}$
- (3)  $T_j = 85\text{ }^\circ\text{C}$
- (4)  $T_j = 25\text{ }^\circ\text{C}$

**Fig 2. Reverse current as a function of reverse voltage; typical values**



$T_{amb} = 25\text{ }^\circ\text{C}; f = 1\text{ MHz}$

**Fig 3. Diode capacitance as a function of reverse voltage; typical values**

## 8. Package outline

Leadless ultra small plastic package; 2 terminals; body 1.0 x 0.6 x 0.5 mm

SOD882

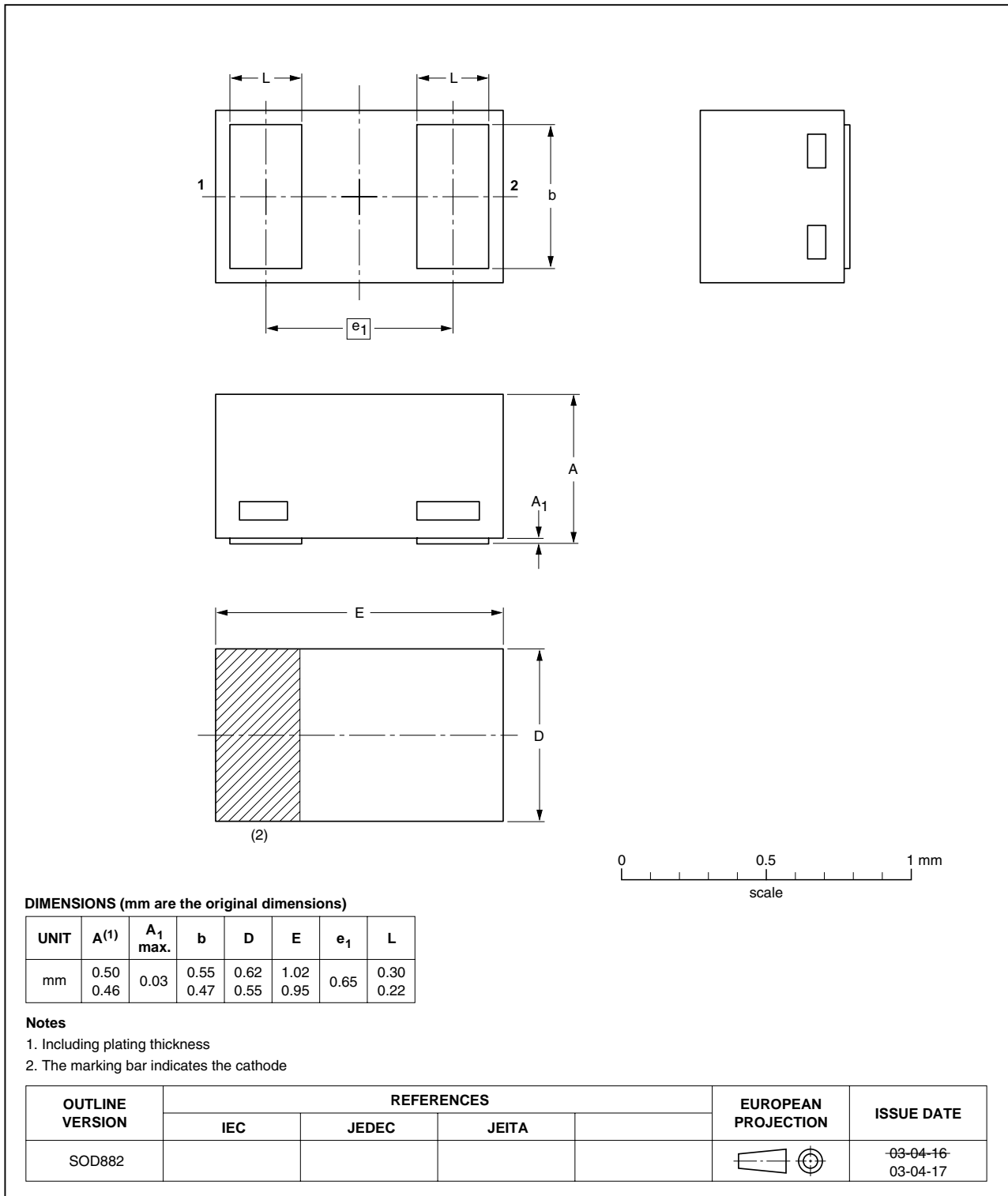


Fig 4. Package outline

## 9. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG2005AEL_3	20100115	Product data	-	PMEG2005AEL_2
Modifications:	<ul style="list-style-type: none"><li>This data sheet was changed to reflect the new company name NXP, including new legal definitions and disclaimers. No changes were made to the technical content.</li></ul>			
PMEG2005AEL_2	20040427	Product data	-	PMEG2005AEL_1
PMEG2005AEL_1	20040419	Product data	-	-

## 10. Legal information

### 10.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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